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INFILTRATION OF MOLTEN SILICON IN A POROUS BODY OF B₄C UNDER MICROWAVE HEATING

Mathieu Dutto^{1,3}, Dominique Goeuriot¹, Sébastien Saunier¹, Sergio Sao-Joao¹, Matthieu Lenci¹, Sylvain Marinel², Shmuel Hayun³, Nachum Frage³

¹ Laboratoire Georges Friedel UMR 5307, Centre des Science des Matériaux et des Structures, Mines Saint-Etienne, 42023 Saint-Etienne Cedex 2, France

² CRISMAT Laboratory UMR 6508 CNRS-ENSICAen-UCBN, 6 Boulevard du Maréchal Juin, 14050 Caen Cedex, France

³ Department of Materials Engineering, Ben-Gurion University of Negev, P.O. Box 653, Beer-Sheva 84105, Israel

ABSTRACT

Boron Carbide is an attractive material for various applications that require high hardness and neutron absorption. Fully dense boron carbide bodies are usually fabricated using hot pressing at temperatures above 2000 °C. Therefore, the production cost is very high, that constitutes the major drawback for widespread applications in the fields of defense and nuclear energy. An alternative route to decrease the production costs is the reaction-bonded technique (RBBC). In this latter, a preform of porous B₄C is obtained by compaction and partial densification. Then the material is infiltrated by molten metal or alloy. The metal can react with residual carbon and boron carbide to form carbide. This technique was extensively studied using conventional furnace but the use of microwave as a source of heating, as not used for this purpose so far, or only in a very few attempts. In the present study, the microstructure and mechanical properties of reaction bonding B₄C infiltrated by silicon using microwave (2.45GHz) heating will be presented. The results will be discussed in the light of conventional RBBC.

INTRODUCTION

Light ceramics are particularly attractive for personal, land and airborne vehicle armor. It is admitted by common consensus that a high ballistic resistance is linked with a high hardness. Boron carbide which is the third harder material nowadays known (42GPa) [1, 2] and very low density (2.52g/cm³), is naturally studied to be used in ballistic protection devices. However their difficulties of production (hot pressing) and production cost are major drawbacks of the extended on boron carbide based armor. An alternative way for the fabrication of boron carbide based armor is to produce a composite of boron carbide and silicon carbide. This composite can be obtained by reaction between melted silicon and boron carbide, this method is called “reaction bonded” process [3, 4]. This method consists in infiltration by molten silicon of a porous green body of boron carbide (called preform) with or without addition of free carbon. The reaction of melted silicon with boron carbide or with free carbon leads to the formation of silicon carbide in the composite. The final composite consists in initial boron carbide grains, newly formed B₁₂(B,C,Si)₃ phase [5], silicon carbide and some unreacted residual silicon. The softer phase is the residual silicon, so to harden the composite it is right to decrease the amount of residual silicon in the final composite. One approach to achieve this goal is to reduce the pre-infiltration porosity of the boron carbide preform; it is common to pre-sintered boron carbide [6]. This approach is fully described in different publications [2,6-11], it was established that SiC phase depends on the carbon source (boron carbide or free carbon). In composite fabricated with free carbon SiC phase appears with a plate-like morphology, while the fabrication of the composite without free carbon leads to SiC with polygonal shape. In addition, boron carbide particles display a core-rim structure and the rim regions, the composition of which correspond to the ternary

$B_{12}(B,C,Si)_3$ [12], interconnect to a large extent the boron carbide particles. The mechanism of the rim-core structure formation has been discussed by Hayun et al [12] and it was attributed to a dissolution-precipitation process in the boron carbide-silicon system.

Most of the previous works were conducted in conventional furnace, only in few studies the use of microwave furnace [13-15] to heat up boron carbide and silicon can be found. Microwaves heating could conduct in preferential heating material that leads to a thermal gradient between two materials in contact and so microstructure different from those obtained by conventional heating. We propose in the present study to investigate the influence of the preform initial porosity and the dwell temperature on the macro/microstructure and hardness of the final composite after heat treatment by microwaves process.

EXPERIMENTAL PROCEDURE

Sample Fabrication

Boron carbide (average size $1\mu m$, HC.Starck, Grade HS) powder was uniaxially compacted at 100 MPa and sintered at 2000 and 2150°C for 30 min in order to obtain preforms with initial density of 67% and 75%. The pre-sintering step was conducted in a furnace under Ar atmosphere, the heating rate was 10°C/min with a minimum 8h dwell at 200°C to remove any residuals of the lubricant used during the compaction.

Three types of preforms (60% (green preform), 67% and 75% (pre-sintered preform) of theoretical density) were infiltrated with molten silicon.

The infiltration process was conducted as follows: A piece of silicon was placed on the top of the porous body. The amount of silicon was chosen in order to fill the porous body. Preforms were infiltrated with molten silicon in a micro-wave furnace at 1350-1550°C range temperature for 15 min with a heating rate of 10°C/min for the design-of-experiment. The infiltration step was realized under $Ar/H_2(10\%)$ atmosphere to avoid oxidation of silicon and the heating was realized in a multimode (2.45GHz, 6kW) cavity with a net volume of 1L. An alumino-silicate made crucible was used for thermal insulation (figure 1). The thermal cycle is realized using the instrumentation developed by Daniel Zymelka [16]. Obtained composites are denoted as their initial density and dwell temperature.

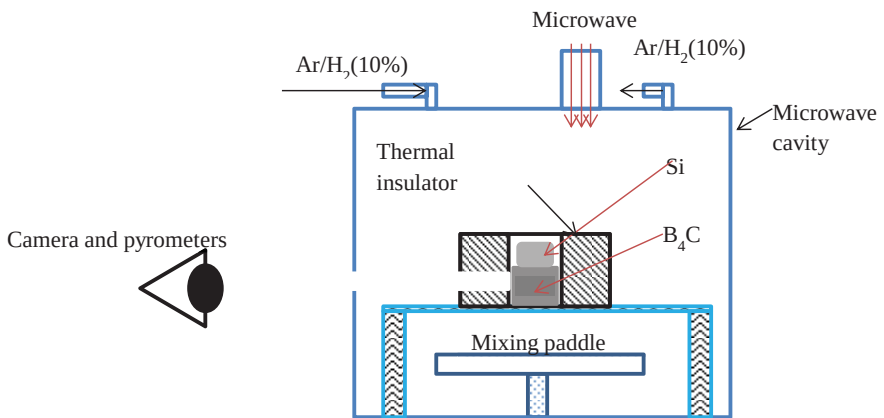


Figure 1: Scheme of the microwave cavity

The temperature was measured with pyrometers, one monochromatic (Ircon, Modeline 5) from 250 to 1000°C and one bichromatic (Ircon, Modline 5) from 700 to 1800°C. Both of

them were calibrated using the reference of silicon melting to found emissivity and e-slop of the system. The conventional error on the temperature measurement is 50°C.

In order to verify the process conditions and our setup we infiltrated a B₄C preform with 84% of the theoretical density using the thermal cycle reported in ref. [12] 1450 °C with 15min of dwell time). From this preliminary test we found that:

1. The melting of silicon is possible by direct microwave heating, and a complete infiltration can be obtained at 1450°C-15min.
2. Using a CCD camera we found that a dwell time of 8 min at 1450 °C is sufficient for complete the infiltration process, which represent a shorter time comparing to the conventional method. (Success infiltration is defined by the absence of visible residual silicon outside of the preform).
3. A large temperature difference was observed between the silicon and the boron carbide preform during the process: the temperature on boron carbide surface is 1280°C when silicon starts to melt (1414°C). This fact could prove the microwave coupling of silicon just before and during its melting.

Based on these findings we design a two dimensional parametric study which allow modeling of the “answer”, in this study *hardness value*, with a second degree polynomial model, on the two dimensions (dwell temperature and initial density) experimental domain. This modeling allows knowing optimum experimental conditions to obtain a high hardness for example. The experimental design chosen is a Doehlert one [17], that consists in three initial densities and five-dwell temperature combined like shown in figure (2).

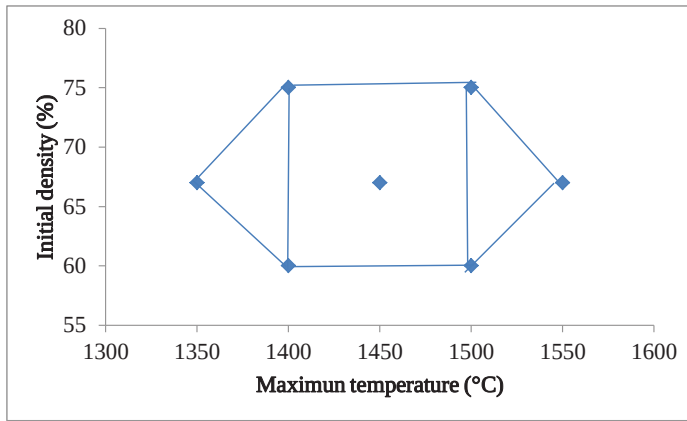


Figure 2: Design-of-experiment for this study. Doehlert plan with two axis (dwell temperature and initial porosity)

The weight percent of evaporated silicon during the infiltration process was calculated from the mass balance of the initial weight of the system (silicon plus boron carbide preform) and the final body as presented in the following equation:

$$W_{\text{Variation}} = \frac{W_{\text{composite}} - (W_{\text{Si}} + W_{\text{B}_4\text{C}})_{\text{initial}}}{(W_{\text{Si}} + W_{\text{B}_4\text{C}})_{\text{initial}}} * 100$$

Microstructural Investigation

The microstructure of the sample was studied by scanning electron microscopy (SEM) (MEB-FEG Jeol 6500F and MEB-FEG Zeiss supra 55 VP), coupled with an energy dispersive spectrometer (EDS) detector. The samples for SEM characterization were prepared using a standard metallographic procedure that included a last stage of polishing with 1 μm diamond paste.

Mechanical Property

Hardness was measured by micro-indentation using a Microdurometer (Matsuzawa MxT70). The hardness measurement was performed on mounted samples for an easier observation of the imprints. Samples were covered with the same thickness of polymers so results can be compared. We used a Vickers device with 300g load and 10s of dwell time to limit cracks to the corners of imprint of hardness

RESULT AND DISCUSSION

Microstructure of the infiltrated composites

Typical microstructure of the infiltrated B_4C composites (Fig. 3) consists of three phases, namely boron carbide, $\beta\text{-SiC}$ and residual silicon. Using the EDS analyses the different phases can be assign. The $\beta\text{-SiC}$ phase appears as light-gray plate-like particles. The lighter-gray regions correspond to residual Si, and the dark gray areas are the boron carbide phase. The mechanism of the reaction between liquid Si and boron carbide has been discussed previously [11].

Differences between the microstructures obtained by conventional furnace and microwaves furnaces could result from temperature gradient between molten silicon (minimum 1414°C) and boron carbide ($\approx 1300^\circ\text{C}$) at the first step of the infiltration.

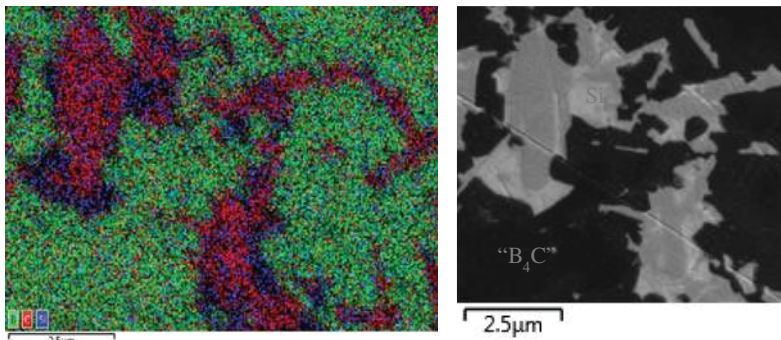


Figure 3: EDS analysis and SEM picture (secondary electron detector) SiC (purple), Si (blue) and a boron rich phase : B_4C and/or $\text{B}_{12}(\text{B,C,Si})_3$ (green-yellow)

The mass variation (i.e. amount of evaporated silicon) for all the experiments is presented in figure 4.

The maximum mass variation is -5%. Microstructures (Fig. 5) of the infiltrated bodies show the presences of some residual porosity. Comparison of two samples with the same initial density shows a low decrease of the final porosity with the increase of the temperature. Increasing initial density seems to decrease the final porosity when the samples are presintered. From these findings, we can conclude that the use of Ar/10%H₂ atmosphere may reduce the silicon evaporation.

Comparing these results to ones obtained in the conventional heat treatment, which often performed in vacuum, suggested that using microwave heating the consumption of silicon can be reduced by half and minimize the needs of additional cleaning steps of the infiltrated body.

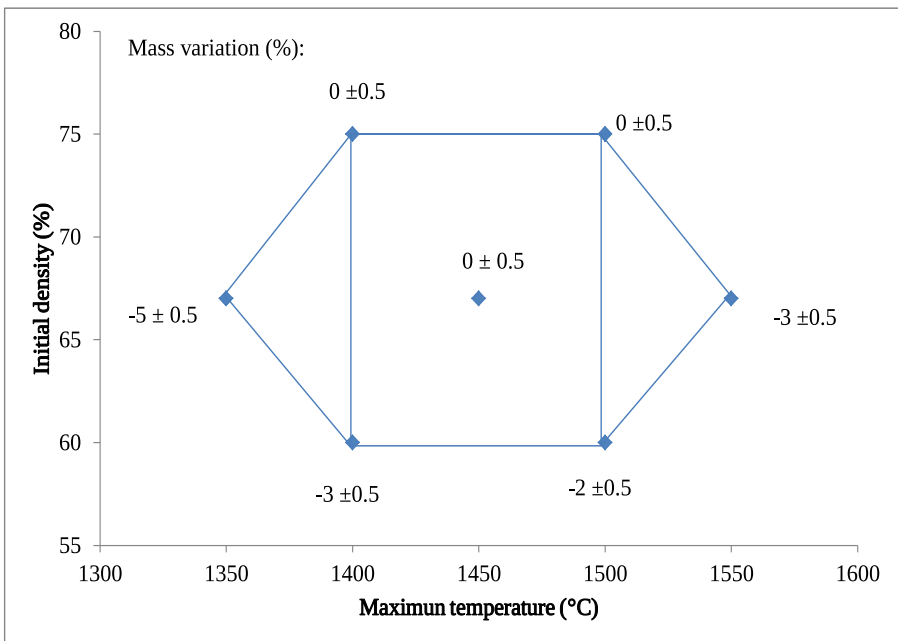


Figure 4: Mass variations on design-of-experiment

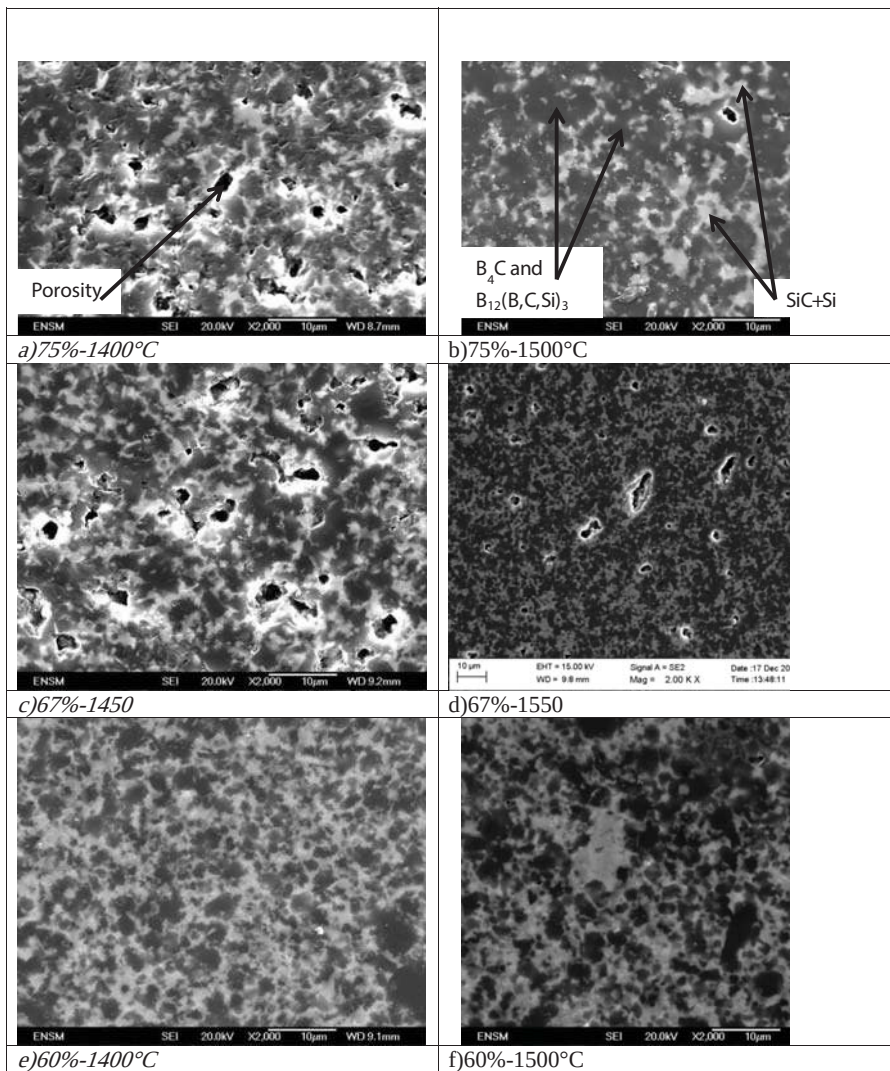


Figure 5: Microstructure (SEM image) of different composite. SEI and SE2 detector (Secondary electron detector).

The hardness values (figure 6), measures increase with the decreasing of initial porosity. The obtained values found to be relatively high, in the range 2150-3140 H_{V300} despite the presence of residual silicon and porosity. On one hand it has to be noted that SiC hardness is lower than that of B_4C , on the other hand the replacement of B_4C by $B_{12}(B,C,Si)_3$ isn't bad for the hardness, indeed according to the bibliography[2] B_4C has a hardness of 42GPa and $B_{12}(B,C,Si)_3$ 46.1GPa. In the present study we couldn't notice on any influence of the treatment temperature on the hardness values. This finding is opposite to the results obtained in conventional method [18] where the influence of the infiltration temperature on the hardness values is strong. We used this data to modeling with Nemrodw software. According to the modeling (figure 7) the influence of the initial porosity found to be increasingly important when it is higher than 67% (the isohardness line getting closer). To optimize final hardness, 75% of initial density and 1400-1500°C of dwell temperature seem to be a good compromise.

According to the ref. [5] composite obtained with conventional heating present hardness of about $2300 \pm 300 H_{V2000}$ which is lower than that obtained for sample treated in microwaves furnace.

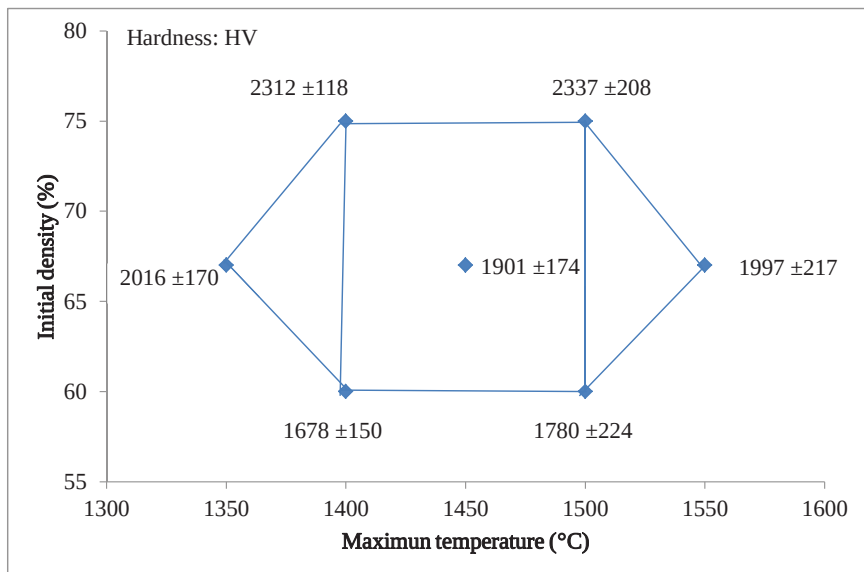


Figure 6: Hardness on design-of-experiment

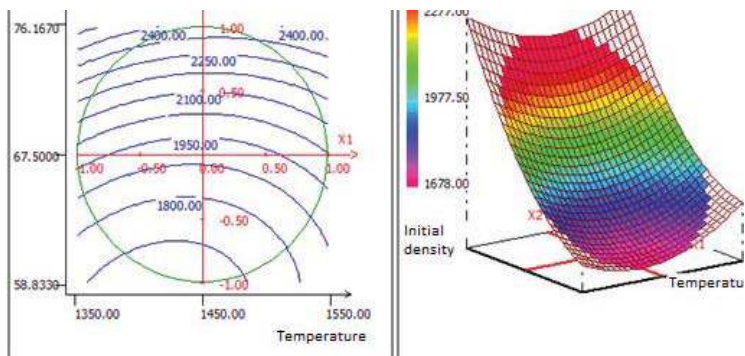


Figure 7: modeling of the influence of the initial porosity on the hardness. Left: 2D representation, blue lines are iso hardness. Right: 3D representation, X1 axis is temperature, X2 axis is initial density and last axis is composite hardness.

CONCLUSION

- The boron carbide reaction bonded method is adaptable to microwave furnace with Ar/H₂ atmosphere.
- The Hardness is strongly depended on the initial density and almost no dependency found on the infiltration temperature.
- The residual porosity is slightly influence by the dwell temperature and the initial density.

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